

# 1SMC5.0AT3G Series, SZ1SMC5.0AT3G Series

## 1500 Watt Peak Power Zener Transient Voltage Suppressors

### Unidirectional\*

The SMC series is designed to protect voltage sensitive components from high voltage, high energy transients. They have excellent clamping capability, high surge capability, low zener impedance and fast response time. The SMC series is supplied in ON Semiconductor's exclusive, cost-effective, highly reliable SURMETIC® package and is ideally suited for use in communication systems, automotive, numerical controls, process controls, medical equipment, business machines, power supplies and many other industrial/consumer applications.

#### Features

- Working Peak Reverse Voltage Range – 5.0 V to 78 V
- Standard Zener Breakdown Voltage Range – 6.7 V to 91.25 V
- Peak Power – 1500 W @ 1 ms
- ESD Rating of Class 3 (> 16 KV) per Human Body Model
- Maximum Clamp Voltage @ Peak Pulse Current
- Low Leakage < 5  $\mu$ A Above 10 V
- UL 497B for Isolated Loop Circuit Protection
- Maximum Temperature Coefficient Specified
- Response Time is Typically < 1 ns
- SZ Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- Pb-Free Packages are Available\*\*

#### Mechanical Characteristics:

**CASE:** Void-free, transfer-molded, thermosetting plastic

**FINISH:** All external surfaces are corrosion resistant and leads are readily solderable

**MAXIMUM CASE TEMPERATURE FOR SOLDERING PURPOSES:**  
260°C for 10 Seconds

**LEADS:** Modified L-Bend providing more contact area to bond pads

**POLARITY:** Cathode indicated by molded polarity notch

**MOUNTING POSITION:** Any

\*\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



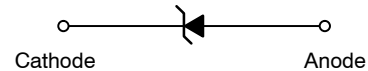
ON Semiconductor®

<http://onsemi.com>

PLASTIC SURFACE MOUNT  
ZENER TRANSIENT  
VOLTAGE SUPPRESSORS  
5.0–78 VOLTS  
1500 WATT PEAK POWER



SMC  
CASE 403  
PLASTIC



#### MARKING DIAGRAM



A = Assembly Location  
Y = Year  
WW = Work Week  
Gxx = Device Code (Refer to page 3)  
▪ = Pb-Free Package

(Note: Microdot may be in either location)

#### ORDERING INFORMATION

Device	Package	Shipping†
1SMCxxxAT3G	SMC (Pb-Free)	2,500 / Tape & Reel
SZ1SMCxxxAT3G	SMC (Pb-Free)	2,500 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

\*Bidirectional devices will not be available in this series.

#### DEVICE MARKING INFORMATION

See specific marking information in the device marking column of the Electrical Characteristics table on page 3 of this data sheet.

# 1SMC5.0AT3G Series, SZ1SMC5.0AT3G Series

## MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Power Dissipation (Note 1) @ $T_L = 25^\circ\text{C}$ , Pulse Width = 1 ms	$P_{PK}$	1500	W
DC Power Dissipation @ $T_L = 75^\circ\text{C}$ Measured Zero Lead Length (Note 2) Derate Above $75^\circ\text{C}$	$P_D$	4.0	W
Thermal Resistance from Junction-to-Lead	$R_{\theta JL}$	54.6 18.3	mW/ $^\circ\text{C}$ $^\circ\text{C}/\text{W}$
DC Power Dissipation (Note 3) @ $T_A = 25^\circ\text{C}$ Derate Above $25^\circ\text{C}$	$P_D$	0.75	W
Thermal Resistance from Junction-to-Ambient	$R_{\theta JA}$	6.1 165	mW/ $^\circ\text{C}$ $^\circ\text{C}/\text{W}$
Forward Surge Current (Note 4) @ $T_A = 25^\circ\text{C}$	$I_{FSM}$	200	A
Operating and Storage Temperature Range	$T_J, T_{stg}$	-65 to +150	$^\circ\text{C}$

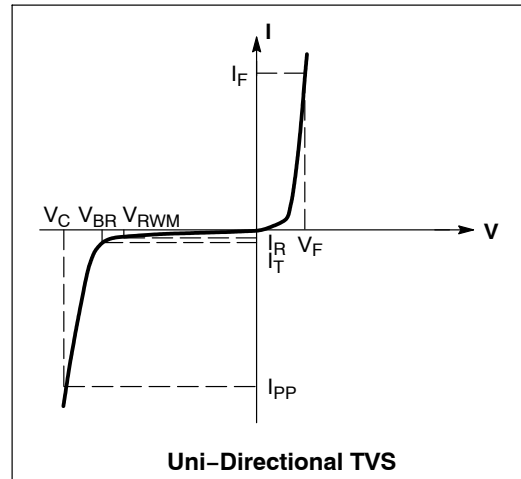
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

- 10 x 1000  $\mu\text{s}$ , non-repetitive.
- 1 in square copper pad, FR-4 board.
- FR-4 board, using ON Semiconductor minimum recommended footprint, as shown in 403 case outline dimensions spec.
- 1/2 sine wave (or equivalent square wave), PW = 8.3 ms, duty cycle = 4 pulses per minute maximum.

**ELECTRICAL CHARACTERISTICS** ( $T_A = 25^\circ\text{C}$  unless otherwise noted,  $V_F = 3.5\text{ V Max @ } I_F = 100\text{ A}$ ) (Note 5)

Symbol	Parameter
$I_{PP}$	Maximum Reverse Peak Pulse Current
$V_C$	Clamping Voltage @ $I_{PP}$
$V_{RWM}$	Working Peak Reverse Voltage
$I_R$	Maximum Reverse Leakage Current @ $V_{RWM}$
$V_{BR}$	Breakdown Voltage @ $I_T$
$I_T$	Test Current
$I_F$	Forward Current
$V_F$	Forward Voltage @ $I_F$

- 1/2 sine wave or equivalent, PW = 8.3 ms non-repetitive duty cycle



# 1SMC5.0AT3G Series, SZ1SMC5.0AT3G Series

## ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C unless otherwise noted)

Device*	Device Marking	V <sub>RWM</sub> (Note 6)	I <sub>R</sub> @ V <sub>RWM</sub>	Breakdown Voltage				V <sub>C</sub> @ I <sub>PP</sub> (Note 8)	
				V <sub>BR</sub> V (Note 7)			@ I <sub>T</sub>	V <sub>C</sub>	I <sub>PP</sub>
				Min	Nom	Max	mA	V	A
1SMC5.0AT3G	GDE	5.0	1000	6.4	6.7	7.0	10	9.2	163
1SMC6.0AT3G	GDG	6.0	1000	6.67	7.02	7.37	10	10.3	145.6
1SMC6.5AT3G	GDK	6.5	500	7.22	7.6	7.98	10	11.2	133.9
1SMC7.5AT3G	GDP	7.5	100	8.33	8.77	9.21	1	12.9	116.3
1SMC8.0AT3G	GDR	8.0	50	8.89	9.36	9.83	1	13.6	110.3
1SMC9.0AT3G	GDV	9.0	10	10	10.55	11.1	1	15.4	97.4
1SMC10AT3G	GDX	10	5	11.1	11.7	12.3	1	17	88.2
1SMC12AT3G	GEE	12	5	13.3	14	14.7	1	19.9	75.3
1SMC13AT3G	GEG	13	5	14.4	15.15	15.9	1	21.5	69.7
1SMC14AT3G	GEK	14	5	15.6	16.4	17.2	1	23.2	64.7
1SMC15AT3G	GEM	15	5	16.7	17.6	18.5	1	24.4	61.5
1SMC16AT3G	GEP	16	5	17.8	18.75	19.7	1	26	57.7
1SMC17AT3G	GER	17	5	18.9	19.9	20.9	1	27.6	53.3
1SMC18AT3G	GET	18	5	20	21.05	22.1	1	29.2	51.4
1SMC20AT3G	GEV	20	5	22.2	23.35	24.5	1	32.4	46.3
1SMC22AT3G	GEX	22	5	24.4	25.65	26.9	1	35.5	42.2
1SMC24AT3G	GEZ	24	5	26.7	28.1	29.5	1	38.9	38.6
1SMC26AT3G	GFE	26	5	28.9	30.4	31.9	1	42.1	35.6
1SMC28AT3G	GFG	28	5	31.1	32.75	34.4	1	45.4	33
1SMC30AT3G	GFK	30	5	33.3	35.05	36.8	1	48.4	31
1SMC33AT3G	GFM	33	5	36.7	38.65	40.6	1	53.3	28.1
1SMC36AT3G	GFP	36	5	40	42.1	44.2	1	58.1	25.8
1SMC40AT3G	GFR	40	5	44.4	46.75	49.1	1	64.5	32.2
1SMC43AT3G	GFT	43	5	47.8	50.3	52.8	1	69.4	21.6
1SMC48AT3G	GFX	48	5	53.3	56.1	58.9	1	77.4	19.4
1SMC51AT3G	GFZ	51	5	56.7	59.7	62.7	1	82.4	18.2
1SMC54AT3G	GGE	54	5	60	63.15	66.3	1	87.1	17.2
1SMC58AT3G	GGG	58	5	64.4	67.8	71.2	1	93.6	16
1SMC60AT3G	GGK	60	5	66.7	70.2	73.7	1	96.8	15.5
1SMC64AT3G	GGM	64	5	71.1	74.85	78.6	1	103	14.6
1SMC70AT3G	GGP	70	5	77.8	81.9	86	1	113	13.3
1SMC75AT3G	GGR	75	5	83.3	87.7	92.1	1	121	12.4
1SMC78AT3G	GGT	78	5	86.7	91.25	95.8	1	126	11.4

6. A transient suppressor is normally selected according to the maximum working peak reverse voltage (V<sub>RWM</sub>), which should be equal to or greater than the DC or continuous peak operating voltage level.

7. V<sub>BR</sub> measured at pulse test current I<sub>T</sub> at an ambient temperature of 25°C.

8. Surge current waveform per Figure 2 and derate per Figure 3 of the General Data – 1500 Watt at the beginning of this group.

\*Include SZ-prefix devices where applicable.

# 1SMC5.0AT3G Series, SZ1SMC5.0AT3G Series

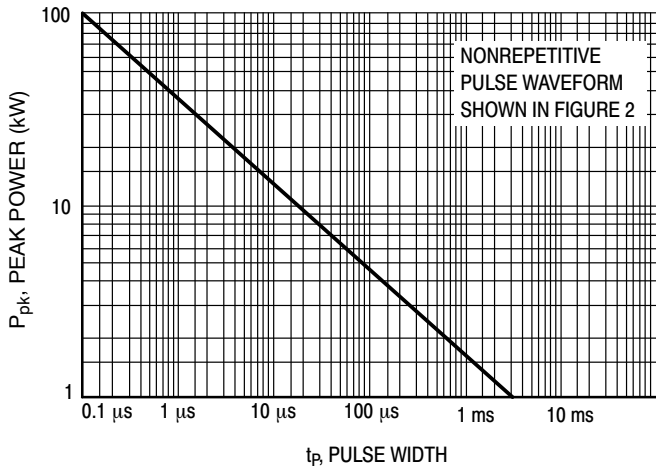


Figure 1. Pulse Rating Curve

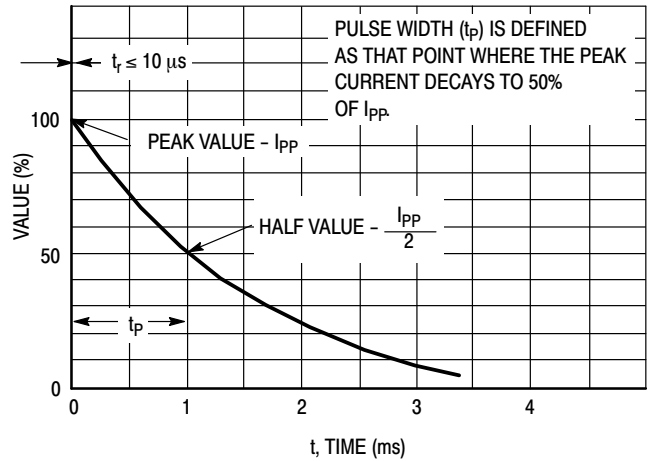


Figure 2. Pulse Waveform

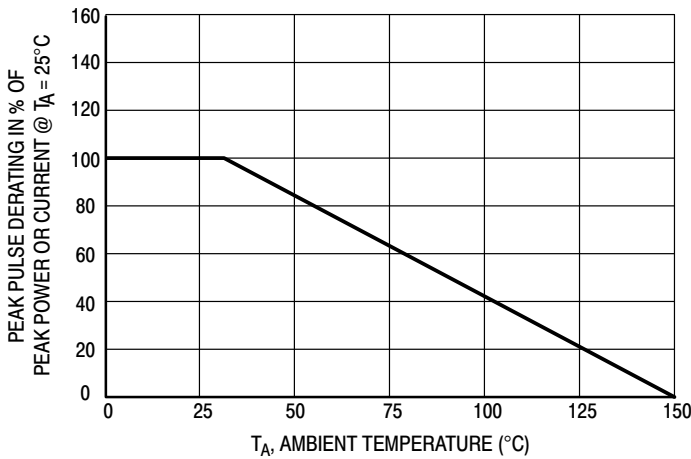


Figure 3. Pulse Derating Curve

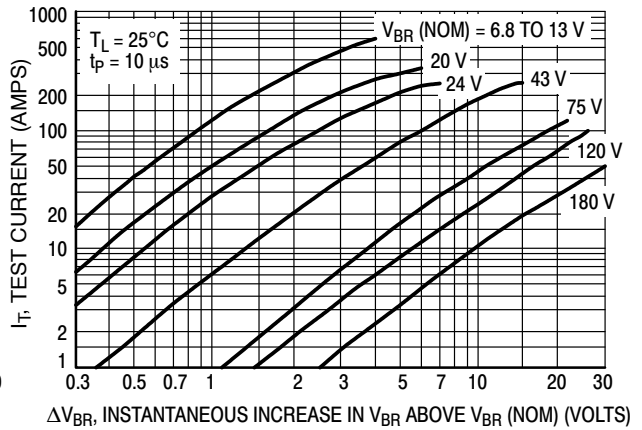


Figure 4. Dynamic Impedance

## UL RECOGNITION

The entire series has *Underwriters Laboratory Recognition* for the classification of protectors (QVGQ2) under the UL standard for safety 497B and File #E210057. Many competitors only have one or two devices recognized or have recognition in a non-protective category. Some competitors have no recognition at all. With the UL497B recognition, our parts successfully passed several tests

including Strike Voltage Breakdown test, Endurance Conditioning, Temperature test, Dielectric Voltage-Withstand test, Discharge test and several more.

Whereas, some competitors have only passed a flammability test for the package material, we have been recognized for much more to be included in their Protector category.

## APPLICATION NOTES

### Response Time

In most applications, the transient suppressor device is placed in parallel with the equipment or component to be protected. In this situation, there is a time delay associated with the capacitance of the device and an overshoot condition associated with the inductance of the device and the inductance of the connection method. The capacitive effect is of minor importance in the parallel protection scheme because it only produces a time delay in the transition from the operating voltage to the clamp voltage as shown in Figure 5.

The inductive effects in the device are due to actual turn-on time (time required for the device to go from zero current to full current) and lead inductance. This inductive effect produces an overshoot in the voltage across the equipment or component being protected as shown in Figure 6. Minimizing this overshoot is very important in the application, since the main purpose for adding a transient suppressor is to clamp voltage spikes. The SMC series have a very good response time, typically < 1 ns and negligible inductance. However, external inductive effects could produce unacceptable overshoot. Proper circuit layout,

minimum lead lengths and placing the suppressor device as close as possible to the equipment or components to be protected will minimize this overshoot.

Some input impedance represented by  $Z_{in}$  is essential to prevent overstress of the protection device. This impedance should be as high as possible, without restricting the circuit operation.

### Duty Cycle Derating

The data of Figure 1 applies for non-repetitive conditions and at a lead temperature of 25°C. If the duty cycle increases, the peak power must be reduced as indicated by the curves of Figure 7. Average power must be derated as the lead or ambient temperature rises above 25°C. The average power derating curve normally given on data sheets may be normalized and used for this purpose.

At first glance the derating curves of Figure 7 appear to be in error as the 10 ms pulse has a higher derating factor than the 10  $\mu$ s pulse. However, when the derating factor for a given pulse of Figure 7 is multiplied by the peak power value of Figure 1 for the same pulse, the results follow the expected trend.

TYPICAL PROTECTION CIRCUIT

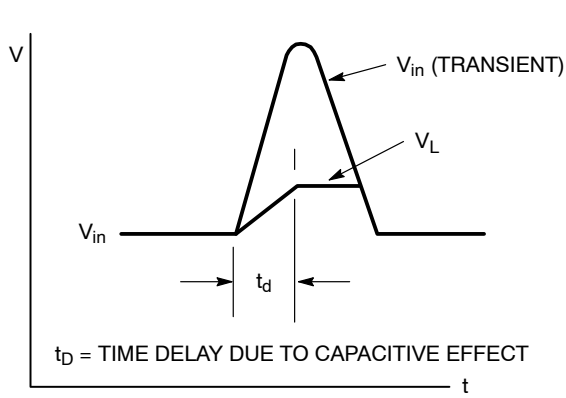
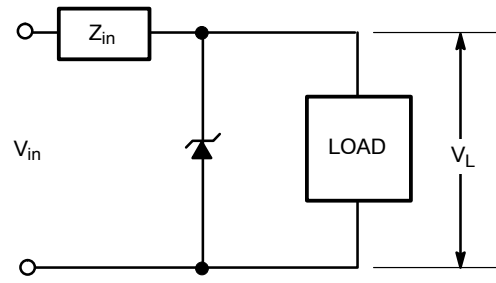


Figure 5.

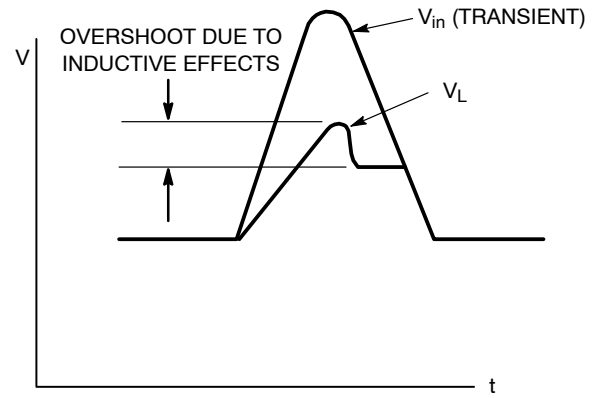


Figure 6.

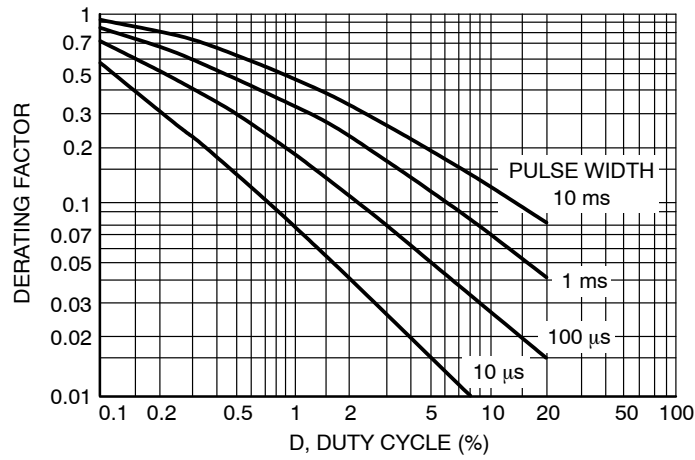
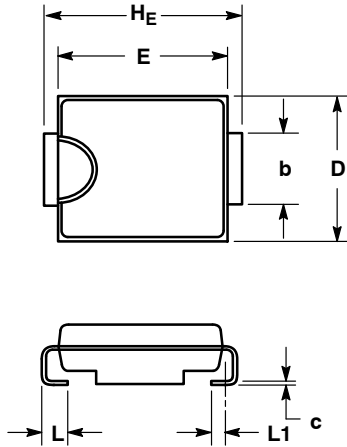


Figure 7. Typical Derating Factor for Duty Cycle

# 1SMC5.0AT3G Series, SZ1SMC5.0AT3G Series

## PACKAGE DIMENSIONS

SMC  
CASE 403-03  
ISSUE E

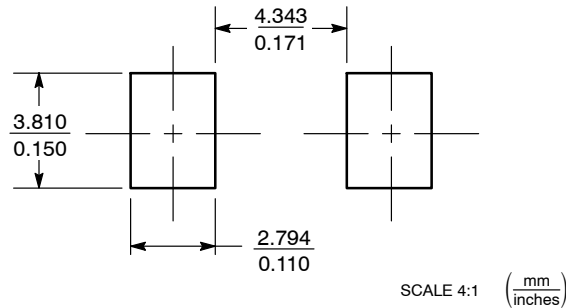


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. D DIMENSION SHALL BE MEASURED WITHIN DIMENSION P.
4. 403-01 THRU -02 OBSOLETE, NEW STANDARD 403-03.

DIM	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	1.90	2.13	2.41	0.075	0.084	0.095
A1	0.05	0.10	0.15	0.002	0.004	0.006
b	2.92	3.00	3.07	0.115	0.118	0.121
c	0.15	0.23	0.30	0.006	0.009	0.012
D	5.59	5.84	6.10	0.220	0.230	0.240
E	6.60	6.86	7.11	0.260	0.270	0.280
HE	7.75	7.94	8.13	0.305	0.313	0.320
L	0.76	1.02	1.27	0.030	0.040	0.050
L1	0.51 REF			0.020 REF		

### SOLDERING FOOTPRINT\*



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

SURMETIC is a registered trademark of Semiconductor Components Industries, LLC.

ON Semiconductor and are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

### PUBLICATION ORDERING INFORMATION

**LITERATURE FULFILLMENT:**  
Literature Distribution Center for ON Semiconductor  
P.O. Box 5163, Denver, Colorado 80217 USA  
**Phone:** 303-675-2175 or 800-344-3860 Toll Free USA/Canada  
**Fax:** 303-675-2176 or 800-344-3867 Toll Free USA/Canada  
**Email:** orderlit@onsemi.com

**N. American Technical Support:** 800-282-9855 Toll Free  
USA/Canada  
**Europe, Middle East and Africa Technical Support:**  
Phone: 421 33 790 2910  
**Japan Customer Focus Center**  
Phone: 81-3-5817-1050

**ON Semiconductor Website:** [www.onsemi.com](http://www.onsemi.com)  
**Order Literature:** <http://www.onsemi.com/orderlit>  
For additional information, please contact your local Sales Representative